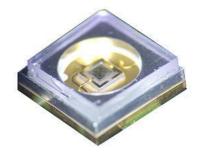
# **Draft Specification For UV-C Series**

# **BRT-B44LD7E1CS0**



#### **Features**

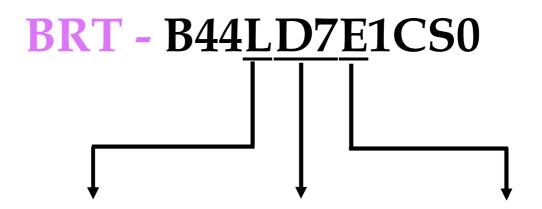
- Deep Ultraviolet LED
- Dimension : 4.4mm(L)×4.4mm(W)
- All Metal Design Cu Substrate/Al reflector
- View Angle 120°
- Low thermal resistance

# **Applications**

- Disinfection
- Chemical and Biological analysis



#### **General Information**



Lens

120° Beam Angle

Wavelength-

Deep UV 265-278nm Current-

20mA

### BIORAYTRON



Do not poke the Led Lens with sharp object



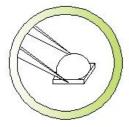
Do not stack assembled PCB



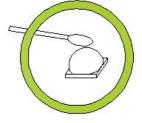
Do not hold the Led with hand



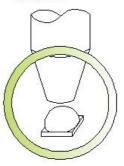
Do not press or push the Led Lens



Hold the Led only by the substrate



Clean the LED surface with cotton bud



Use pick and place nozzle per recommendation in data sheet

### **Absolute Maximum Ratings**

(Tj=25°€)

Parameter	Symbol	Value	Unit
Power Dissipation	P	0.3 W	
Forward Current	$\mathbf{I_F}$	30	mA
Thermal Resistance, Junction-Case	R <sub>th</sub> , J-C1	15 °C/W	
Operating Temperature Range	$T_{opr}$	- 40°C to + 60°C	
Storage Temperature Range	$T_{\mathrm{stg}}$	- 40°C to + 100°C	
Soldering Condition	$T_{sol}$	260°C For 5 Seconds	

Note: 1. The thermal resistance value is measured with MCPCB (Star).

## **Initial Electrical/Optical Characteristics**

(Tj=25°C)

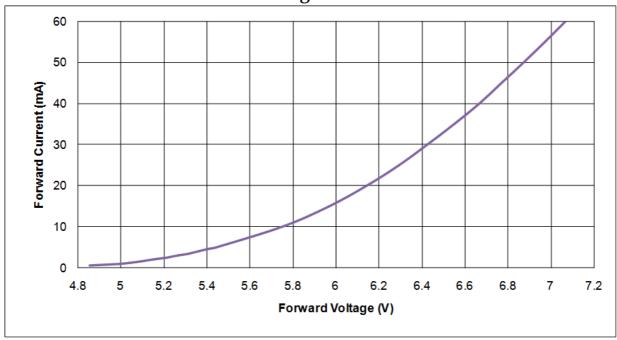
Parameter	Symbol	Min	Тур	Max	Test Condition	Unit
Peak wavelength	$\lambda_{\mathrm{p}}$	265	-	278		nm
Radiant Flux	$\Phi_{ m e}$	1	1.5	-		mW
Radiant Irradiance	E <sub>e</sub>	-	0.4	-	$I_F = 20 \text{mA}$	mW/cm^2
Forward Voltage	$\mathbf{V}_{\mathbf{F}}$	-	6.5	10		V
Spectra half-width	Δλ	-	15	-		nm

#### Note

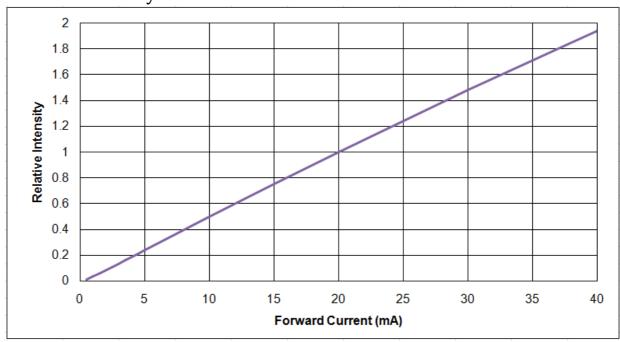
- 1. Forward voltage measurement allowance is  $\pm$  0.2V.
- 2. Radiant flux measurement allowance is  $\pm 10\%$ .
- 3. Irradiance tested at a distance 10mm from Al reflector.
- 4. Wavelength measurement allowance is ± 3nm.

### **Characteristic Diagram**

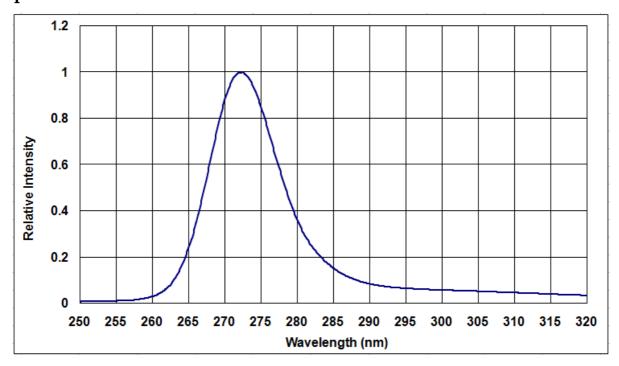
### • Forward Current vs. Forward Voltage



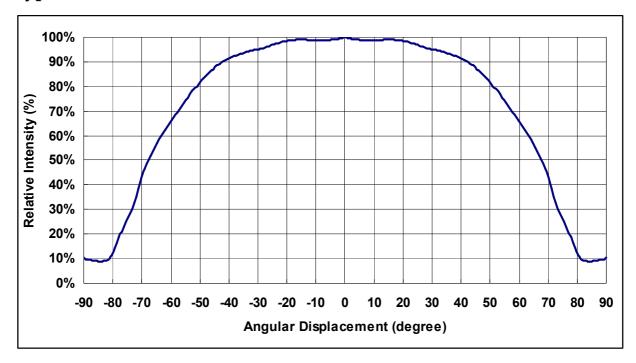
### • Relative Intensity vs. Forward Current



### • Spectral Power Distribution



### • Typical Radiation Pattern





### • Bin Code List for Reference

(Tj=25°℃)

Item	Bin code	Symbol	Condition	Min.	Max.	Unit
Forward Voltage <sup>1</sup>	Е	$ m V_F$	I <sub>F</sub> =20 [mA]	5	6	
	F			6	7	
	G			7	8	V
	Н			8	9	
	J			9	10	

Note

1. Forward voltage measurement allowance is  $\pm$  0.2V.

### **Outline Dimension**

#### **B44LD7E1CS0**

Unit: mm

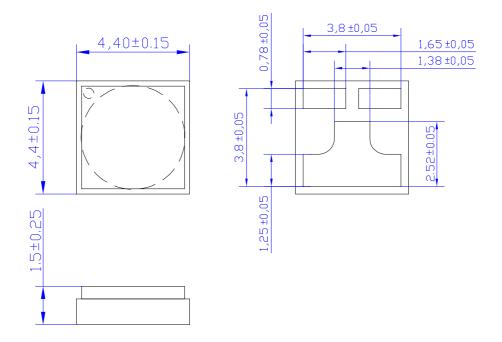
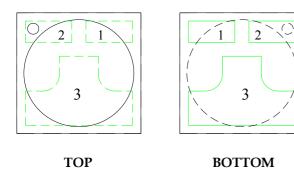


Fig. Package Outline Drawing.

### **Pad Configuration**

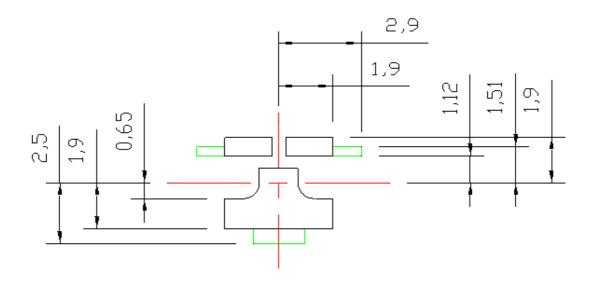


PAD	Function			
1	Cathode			
2	Anode			
3	Thermal			

. 1

Fig. Pad configuration.

### **Recommended Solder Pattern**



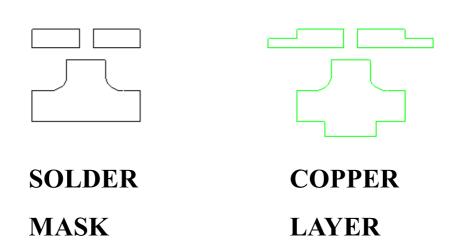


Fig. Solder Pad Layout.

### **Shipping Package Style**

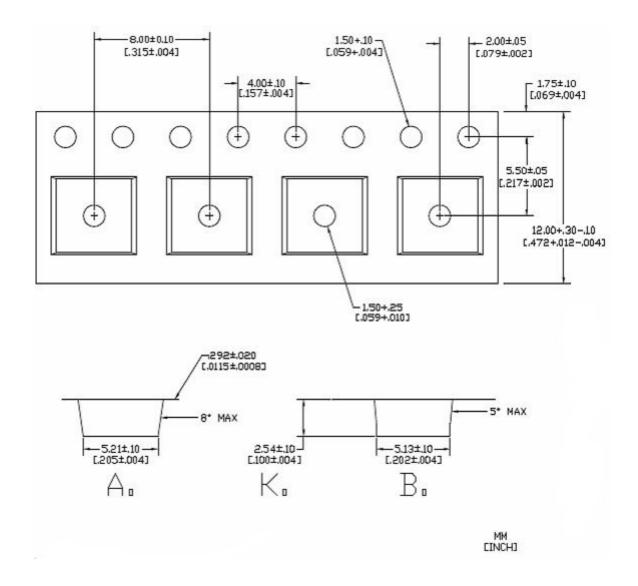
## Lens Type

### **Tapping Dimension Packaging Specification**

#### 120 Degree Lens Type:

- Moisture proof bag.
- 1 Reel/bag.
- Q'ty: 800(MAX)/Reel.

Unit: mm



#### **Label Formation**

P/N: XXXXXXXXXXXXXXX BIN Rank: XXXXXXXXXXX LOT: XXXXXXXXXXXXXXXXX Q'ty: XXXXPCS XXX

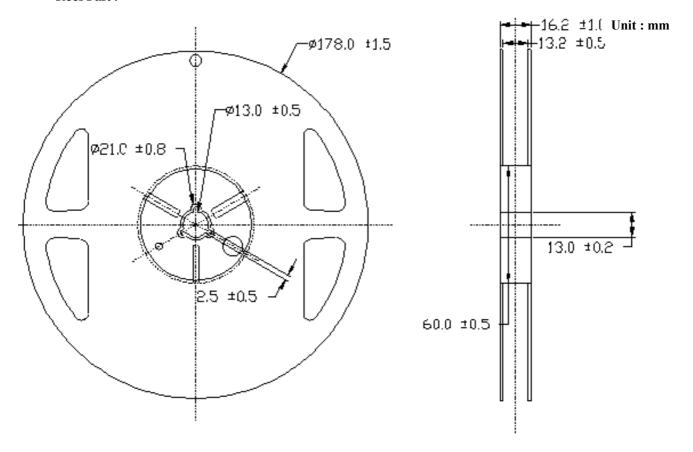
75mm\*8mm

### Package

Вох Туре	Dimension (mm)	Reel/Box	120°Lens Type(Pcs)
Small Box(S)	230x85x265	5 Reel/Box	4000
Middle Box(M)	470x265x270	30 Reel/Box	24000
Large Box(L)	470x435x270	50 Reel/Box	40000

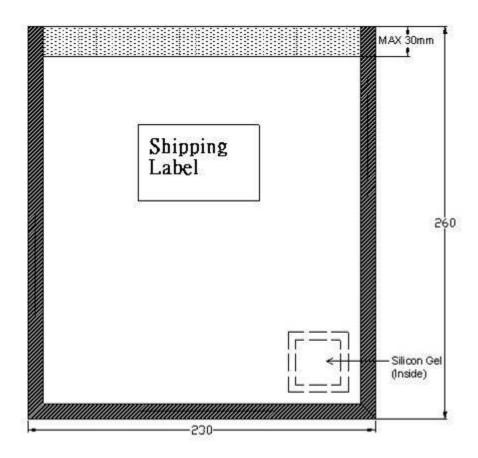
### Reel Packaging:

Reel Part:



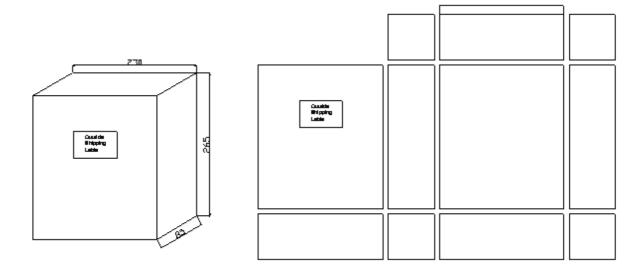
## Anti Statistic Bag:

Unit: mm

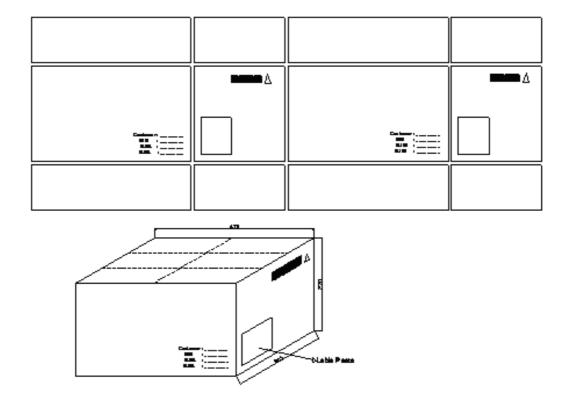


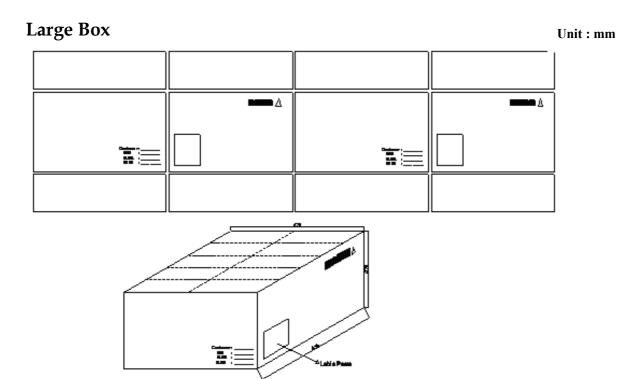
### **Small Box**

Unit: mm



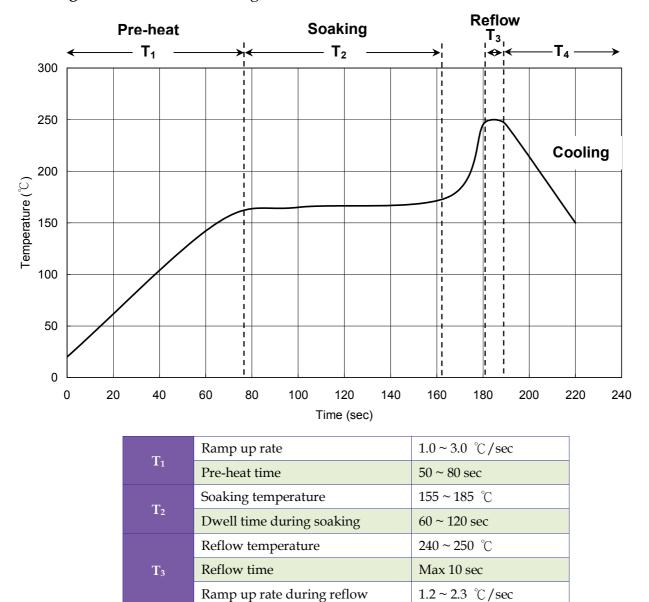
Middle Box Unit: mm





### **Recommended Solder Profile**

**Soldering** Recommended soldering conditions:



Note: Suggest using Sn96Ag3Cu0.5 lead free solder.

Cooling

 $1.0 \sim 6.0 \, ^{\circ}\text{C/sec}$ 

#### Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.



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